



Intel® Xeon® Processor E5-2697 v3

35M Cache, 2.60 GHz

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| Specifications | Compatible Products | Benchmarks | Ordering and Compliance |
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Essentials

Export specifications

| | | | |
|--------------------|-------------------------------------|----------------------------|---------------------------|
| Product Collection | Intel® Xeon® Processor E5 v3 Family | Code Name | Products formerly Haswell |
| Vertical Segment | Server | Processor Number | E5-2697V3 |
| Status | Launched | Launch Date | Q3'14 |
| Lithography | 22 nm | Recommended Customer Price | - |

Performance

| | | | |
|--------------------------|------------------|---------------------|--------------|
| # of Cores | 14 | # of Threads | 28 |
| Processor Base Frequency | 2.60 GHz | Max Turbo Frequency | 3.60 GHz |
| Cache | 35 MB SmartCache | Bus Speed | 9.6 GT/s QPI |
| # of QPI Links | 2 | TDP | 145 W |
| VID Voltage Range | 0.65V–1.30V | | |

Supplemental Information

| | | | |
|----------------------------|----------|---------------|----------|
| Embedded Options Available | No | Conflict Free | Yes |
| Datasheet | View now | Product Brief | View now |
| Additional Information URL | View now | | |

Learn how Intel is pursuing conflict-free technology.



Memory Specifications

| | | | |
|--|--------|--------------------------|---------------------|
| Max Memory Size (dependent on memory type) | 768 GB | Memory Types | DDR4 1600/1866/2133 |
| | | Max # of Memory Channels | 4 |

Max Memory Bandwidth [?](#) 68 GB/s

Physical Address Extensions [?](#)

46-bit

ECC Memory Supported [?](#) [Q](#)

Yes

Graphics Specifications

Processor Graphics [?](#)

None

Expansion Options

Scalability

2S

PCI Express Revision [?](#)

3.0

PCI Express Configurations [?](#)

x4, x8, x16

Max # of PCI Express Lanes [?](#)

40

Package Specifications

Sockets Supported [?](#)

FCLGA2011-3

Max CPU Configuration

2

T_{CASE} [?](#)

76.7°C

Package Size

52.5mm x 51mm

Low Halogen Options Available

See MDDS

Advanced Technologies

Intel® Turbo Boost Technology [?](#)

2.0

Intel® vPro Technology [?](#) [Q](#)

Yes

Intel® Hyper-Threading Technology [?](#) [Q](#)

Yes

Intel® Virtualization Technology (VT-x) [?](#)

Yes

Intel® Virtualization Technology for Directed I/O (VT-d)

[?](#) [Q](#)

Yes

Intel® VT-x with Extended Page Tables (EPT) [?](#) [Q](#)

Yes

Intel® TSX-NI [?](#)

No

Intel® 64 [?](#) [Q](#)

Yes

Instruction Set [?](#)

64-bit

Instruction Set Extensions [?](#)

AVX 2.0

Idle States [?](#)

Yes

Enhanced Intel SpeedStep® Technology [?](#) [Q](#)

Yes

Intel® Demand Based Switching [?](#) [Q](#)

Yes

Thermal Monitoring Technologies [?](#)

Yes

Intel® Flex Memory Access [?](#)

No

Intel® Identity Protection Technology [?](#)

No

Intel® Data Protection Technology

Intel® AES New Instructions [?](#) [Q](#)

Yes

Secure Key [?](#)

Yes

Intel® Platform Protection Technology

OS Guard

Yes

Trusted Execution Technology [?](#) [Q](#)

Yes

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Refer to Datasheet for formal definitions of product properties and features.

"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability.

Some products can support AES New Instructions with a Processor Configuration update, in particular, i7-2630QM/i7-2635QM, i7-2670QM/i7-2675QM, i5-2430M/i5-2435M, i5-2410M/i5-2415M. Please contact OEM for the BIOS that includes the latest Processor configuration update.

‡ This feature may not be available on all computing systems. Please check with the system vendor to determine if your system delivers this feature, or reference the system specifications (motherboard, processor, chipset, power supply, HDD, graphics controller, memory, BIOS, drivers, virtual machine monitor-VMM, platform software, and/or operating system) for feature compatibility. Functionality, performance, and other benefits of this feature may vary depending on system configuration.

"Conflict free" and "conflict-free" means "DRC conflict free", which is defined by the U.S. Securities and Exchange Commission rules to mean products that do not contain conflict minerals (tin, tantalum, tungsten and/or gold) that directly or indirectly finance or benefit armed groups in the Democratic Republic of the Congo (DRC) or adjoining countries. Intel also uses the term "conflict-free" in a broader sense to refer to suppliers, supply chains, smelters and refiners whose sources of conflict minerals do not finance conflict in the DRC or adjoining countries. Intel processors manufactured before January 1, 2013 are not confirmed conflict free. The conflict free designation refers only to product manufactured after that date. For Intel Boxed Processors, the conflict free designation refers to the processor only, not to any additional included accessories, such as heatsinks/coolers.

See <http://www.intel.com/content/www/us/en/architecture-and-technology/hyper-threading/hyper-threading-technology.html?wapkw=hyper+threading> for more information including details on which processors support Intel® HT Technology.

Max Turbo Frequency refers to the maximum single-core processor frequency that can be achieved with Intel® Turbo Boost Technology. See www.intel.com/technology/turboboost/ for more information.

The Recommended Customer –unit purchase quantities, and are subject to change without notice. Taxes and shipping, etc. not included. Prices may vary for other package types and shipment quantities, and special promotional arrangements may apply. If sold in bulk, price represents individual unit. Listing of these RCP does not constitute a formal pricing offer from Intel. Please work with your appropriate Intel representative to obtain a formal price quotation.

System and Maximum TDP is based on worst case scenarios. Actual TDP may be lower if not all I/Os for chipsets are used.

Low Halogen: Applies only to brominated and chlorinated flame retardants (BFRs/CFRs) and PVC in the final product. Intel components as well as purchased components on the finished assembly meet JS-709 requirements, and the PCB / substrate meet IEC 61249-2-21 requirements. The replacement of halogenated flame retardants and/or PVC may not be better for the environment.

For benchmarking data see <http://www.intel.com/performance>.

Intel processor numbers are not a measure of performance. Processor numbers differentiate features within each processor family, not across different processor families. See <http://www.intel.com/content/www/us/en/processors/processor-numbers.html> for details.

Processors that support 64-bit computing on Intel® architecture require an Intel 64 architecture-enabled BIOS.

More support options for Intel® Xeon® Processor E5-2697 v3 (35M Cache, 2.60 GHz)



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